SIEMENS

Data sheet



SIMATIC DP, CPU 1512SP F-1 PN for ET 200SP, Central processing unit with Work memory 300 KB for program and 1 MB for data, 1st interface: PROFINET IRT with 3-port switch, 48 ns bit performance, SIMATIC Memory Card required, BusAdapter required for Port 1 and 2

General information	
Product type designation	CPU 1512SP F-1 PN
HW functional status	FS05
Firmware version	V2.9
Product function	
• I&M data	Yes; I&M0 to I&M3
 Module swapping during operation (hot swapping) 	Yes; Multi-hot swapping
 Isochronous mode 	Yes; Only with PROFINET; with minimum OB $6x$ cycle of $625~\mu s$
Engineering with	
 STEP 7 TIA Portal configurable/integrated from version 	V17 (FW V2.9) / V13 SP1 Update 4 (FW V1.8) or higher
Configuration control	
via dataset	Yes
Control elements	
Mode selector switch	1
Supply voltage	
Rated value (DC)	24 V
permissible range, lower limit (DC)	19.2 V
permissible range, upper limit (DC)	28.8 V
Reverse polarity protection	Yes
Mains buffering	
 Mains/voltage failure stored energy time 	5 ms
Input current	
Current consumption (rated value)	0.6 A
Current consumption, max.	0.9 A
Inrush current, max.	4.7 A; Rated value
l²t	0.14 A²·s
Power	
Infeed power to the backplane bus	8.75 W
Power loss	
Power loss, typ.	5.6 W
Memory	
Number of slots for SIMATIC memory card	1
SIMATIC memory card required	Yes
Work memory	
• integrated (for program)	300 kbyte
• integrated (for data)	1 Mbyte
Load memory	
Plug-in (SIMATIC Memory Card), max.	32 Gbyte
Backup	
maintenance-free	Yes

CPU processing times	
for bit operations, typ.	48 ns
for word operations, typ.	58 ns
	77 ns
for fixed point arithmetic, typ. for floating point arithmetic, typ.	307 ns
CPU-blocks	307 118
	4 000 Plants (OR ER EO DR) and URT-
Number of elements (total)	4 000; Blocks (OB, FB, FC, DB) and UDTs
DB	4 00 000 1 11 11 11 1 1 1 1 1 1 1 1 1 1
Number range	1 60 999; subdivided into: number range that can be used by the user: 1 59 999, and number range of DBs created via SFC 86: 60 000 60 999
• Size, max.	1 Mbyte; For DBs with absolute addressing, the max. size is 64 KB
FB	, , , , , , , , , , , , , , , , , , ,
Number range	0 65 535
• Size, max.	200 kbyte
FC FC	
Number range	0 65 535
• Size, max.	200 kbyte
OB	
• Size, max.	200 kbyte
Number of free cycle OBs	100
Number of time alarm OBs	20
Number of delay alarm OBs	20
Number of cyclic interrupt OBs	20; With minimum OB 3x cycle of 500 μs
Number of process alarm OBs	50
Number of DPV1 alarm OBs	3
Number of isochronous mode OBs	1
Number of technology synchronous alarm OBs	2
Number of startup OBs	100
Number of asynchronous error OBs	4
Number of synchronous error OBs	2
Number of diagnostic alarm OBs	1
Nesting depth	
per priority class	24; Up to 8 possible for F-blocks
Counters, timers and their retentivity	
S7 counter	
Number	2 048
Retentivity	
— adjustable	Yes
IEC counter	
Number	Any (only limited by the main memory)
Retentivity	, , , , , , , , , , , , , , , , , , , ,
— adjustable	Yes
S7 times	
• Number	2 048
Retentivity	
— adjustable	Yes
IEC timer	
• Number	Any (only limited by the main memory)
Retentivity	, (, , , , , , , , , , , , , , , , , ,
— adjustable	Yes
Data areas and their retentivity	
Retentive data area (incl. timers, counters, flags), max.	128 kbyte; Available retentive memory for bit memories, timers, counters, DBs,
	and technology data (axes): 88 KB
Flag	
• Size, max.	16 kbyte
Number of clock memories	8; 8 clock memory bit, grouped into one clock memory byte
Data blocks	
Retentivity adjustable	Yes
Retentivity preset	No
Local data	
per priority class, max.	64 kbyte; max. 16 KB per block
the state of the s	

Address area	
Number of IO modules	2 048; max. number of modules / submodules
I/O address area	
• Inputs	32 kbyte; All inputs are in the process image
Outputs	32 kbyte; All outputs are in the process image
per integrated IO subsystem	
— Inputs (volume)	8 kbyte
— Outputs (volume)	8 kbyte
per CM/CP	
— Inputs (volume)	8 kbyte
Outputs (volume)	8 kbyte
Subprocess images	
 Number of subprocess images, max. 	32
Address space per module	
Address space per module, max.	288 byte; For input and output data respectively
Address space per station	
Address space per station, max.	2 560 byte; for central inputs and outputs; depending on configuration; 2 048 bytes for ET 200SP modules + 512 bytes for ET 200AL modules
Hardware configuration	
Number of distributed IO systems	32; A distributed I/O system is characterized not only by the integration of distributed I/O via PROFINET or PROFIBUS communication modules, but also by the connection of I/O via AS-i master modules or links (e.g. IE/PB-Link)
Number of DP masters	
• Via CM	1
Number of IO Controllers	
• integrated	1
• Via CM	0
Rack	
Modules per rack, max.	80; CPU + 64 modules + server module (mounting width max. 1 m) + 16 ET 200AL modules
 Quantity of operable ET 200SP modules, max. 	64
 Quantity of operable ET 200AL modules, max. 	16
PtP CM	
Number of PtP CMs	the number of connectable PtP CMs is only limited by the number of available slots
Time of day	
Clock	
• Type	Hardware clock
Backup time	6 wk; At 40 °C ambient temperature, typically
Deviation per day, max.	10 s; Typ.: 2 s
Operating hours counter	
Number	16
Clock synchronization	
supported	Yes
	res
• to DP, master	Yes; Via CM DP module
to DP, masterto DP, slave	
	Yes; Via CM DP module
• to DP, slave	Yes; Via CM DP module Yes; Via CM DP module
to DP, slavein AS, master	Yes; Via CM DP module Yes; Via CM DP module Yes
 to DP, slave in AS, master in AS, slave on Ethernet via NTP 	Yes; Via CM DP module Yes; Via CM DP module Yes Yes
 to DP, slave in AS, master in AS, slave on Ethernet via NTP 	Yes; Via CM DP module Yes; Via CM DP module Yes Yes
 to DP, slave in AS, master in AS, slave on Ethernet via NTP 	Yes; Via CM DP module Yes; Via CM DP module Yes Yes Yes Yes
to DP, slave in AS, master in AS, slave on Ethernet via NTP Interfaces Number of PROFINET interfaces	Yes; Via CM DP module Yes; Via CM DP module Yes Yes Yes Yes
to DP, slave in AS, master in AS, slave on Ethernet via NTP Interfaces Number of PROFINET interfaces Number of PROFIBUS interfaces Optical interface	Yes; Via CM DP module Yes; Via CM DP module Yes Yes Yes 1 1; Via CM DP module
to DP, slave in AS, master in AS, slave on Ethernet via NTP Interfaces Number of PROFINET interfaces Number of PROFIBUS interfaces Optical interface	Yes; Via CM DP module Yes; Via CM DP module Yes Yes Yes 1 1; Via CM DP module
to DP, slave in AS, master in AS, slave on Ethernet via NTP Interfaces Number of PROFINET interfaces Number of PROFIBUS interfaces Optical interface Interface types	Yes; Via CM DP module Yes; Via CM DP module Yes Yes Yes Yes 1 1; Via CM DP module Yes; via BusAdapter
to DP, slave in AS, master in AS, slave on Ethernet via NTP Interfaces Number of PROFINET interfaces Number of PROFIBUS interfaces Optical interface Interface Interface Interface types RJ 45 (Ethernet)	Yes; Via CM DP module Yes; Via CM DP module Yes Yes Yes Yes 1 1; Via CM DP module Yes; via BusAdapter Yes; Via BusAdapter
to DP, slave in AS, master in AS, slave on Ethernet via NTP Interfaces Number of PROFINET interfaces Number of PROFIBUS interfaces Optical interface Interface Interface Interface types RJ 45 (Ethernet) Number of ports	Yes; Via CM DP module Yes; Via CM DP module Yes Yes Yes Yes 1 1; Via CM DP module Yes; via BusAdapter
to DP, slave in AS, master in AS, slave on Ethernet via NTP Interfaces Number of PROFINET interfaces Number of PROFIBUS interfaces Optical interface Interface Interface PRJ 45 (Ethernet) Number of ports integrated switch	Yes; Via CM DP module Yes; Via CM DP module Yes Yes Yes Yes 1 1; Via CM DP module Yes; via BusAdapter Yes; via BusAdapter Yes; X1 P3; opt. X1 P1 and X1 P2 via BusAdapter BA 2x RJ45 3; 1. integr. + 2. via BusAdapter Yes
to DP, slave in AS, master in AS, slave on Ethernet via NTP Interfaces Number of PROFINET interfaces Number of PROFIBUS interfaces Optical interface 1. Interface Interface types RJ 45 (Ethernet) Number of ports integrated switch BusAdapter (PROFINET)	Yes; Via CM DP module Yes; Via CM DP module Yes Yes Yes Yes 1 1; Via CM DP module Yes; via BusAdapter Yes; via BusAdapter Yes; X1 P3; opt. X1 P1 and X1 P2 via BusAdapter BA 2x RJ45 3; 1. integr. + 2. via BusAdapter
to DP, slave in AS, master in AS, slave on Ethernet via NTP Interfaces Number of PROFINET interfaces Number of PROFIBUS interfaces Optical interface Interface Interface PRJ 45 (Ethernet) Number of ports integrated switch	Yes; Via CM DP module Yes Yes Yes Yes Yes Yes 1 1; Via CM DP module Yes; via BusAdapter Yes; via BusAdapter Yes; X1 P3; opt. X1 P1 and X1 P2 via BusAdapter BA 2x RJ45 3; 1. integr. + 2. via BusAdapter Yes

PROFINET IO Device	Yes
SIMATIC communication	Yes
Open IE communication	Yes; Optionally also encrypted
Web server	Yes
Media redundancy	Yes; MRP Automanager according to IEC 62439-2 Edition 2.0
PROFINET IO Controller	
Services	
— PG/OP communication	Yes
— Isochronous mode	Yes
— Direct data exchange	Yes; Requirement: IRT and isochronous mode (MRPD optional)
— IRT	Yes
— PROFlenergy	Yes; per user program
— Prioritized startup	Yes; Max. 32 PROFINET devices
Number of connectable IO Devices, max.	128; In total, up to 512 distributed I/O devices can be connected via AS-i, PROFIBUS or PROFINET
— Of which IO devices with IRT, max.	64
Number of connectable IO Devices for RT, max.	128
— of which in line, max.	128
 Number of IO Devices that can be simultaneously activated/deactivated, max. 	8; in total across all interfaces
Number of IO Devices per tool, max.	8
— Updating times	The minimum value of the update time also depends on communication share set for PROFINET IO, on the number of IO devices, and on the quantity of configured user data
Update time for IRT	J. 122 222 220
— for send cycle of 250 μs	250 μ s to 4 ms; Note: In the case of IRT with isochronous mode, the minimum update time of 500 μ s of the isochronous OB is decisive
— for send cycle of 500 μs	500 μs to 8 ms
— for send cycle of 1 ms	1 ms to 16 ms
— for send cycle of 2 ms	2 ms to 32 ms
— for send cycle of 4 ms	4 ms to 64 ms
— With IRT and parameterization of "odd" send cycles	Update time = set "odd" send clock (any multiple of 125 μ s: 375 μ s, 625 μ s 3 875 μ s)
Update time for RT	
— for send cycle of 250 μs	250 μs to 128 ms
— for send cycle of 500 μs	500 μs to 256 ms
— for send cycle of 1 ms	1 ms to 512 ms
— for send cycle of 2 ms	2 ms to 512 ms
— for send cycle of 4 ms	4 ms to 512 ms
PROFINET IO Device	
Services	
— PG/OP communication	Yes
— Isochronous mode	No
— IRT	Yes
— PROFlenergy	Yes; per user program
— Shared device	Yes
Number of IO Controllers with shared device, max.	4
activation/deactivation of I-devices	Yes; per user program
Asset management record	Yes; per user program
2. Interface	
Interface types	V // 04 PP
• RS 485	Yes; Via CM DP module
Number of ports	1
Protocols	
PROFIBUS DP master	Yes
PROFIBUS DP slave NAATIO communication	Yes
SIMATIC communication	Yes
PROFIBUS DP master	40. Of which 4 cook as a 16 EQ 1111
Number of connections, max. Number of DD alous a graph.	48; Of which 4 each reserved for ES and HMI
Number of DP slaves, max.	125; In total, up to 512 distributed I/O devices can be connected via AS-i, PROFIBUS or PROFINET
Services	
— PG/OP communication	Yes

— Equidistance	No
Equidistance Isochronous mode	No
Activation/deactivation of DP slaves	Yes
Interface types	165
RJ 45 (Ethernet)	
• 100 Mbps	Yes
Autonegotiation	Yes
Autoregoliation Autorossing	Yes
Industrial Ethernet status LED	Yes
RS 485	166
Transmission rate, max.	12 Mbit/s
Protocols	
PROFIsafe	Yes; V2.4 / V2.6
Number of connections	
Number of connections, max.	128; via integrated interfaces of the CPU and connected CPs / CMs
 Number of connections reserved for ES/HMI/web 	10
 Number of connections via integrated interfaces 	88
Number of connections per CP/CM	32
Number of S7 routing paths	16
Redundancy mode	
H-Sync forwarding	Yes
Media redundancy	
— Media redundancy	Yes; only via BusAdapter
— MRP	Yes; MRP Automanager according to IEC 62439-2 Edition 2.0, MRP Manager; MRP Client
 MRP interconnection, supported 	Yes; as MRP ring node according to IEC 62439-2 Edition 3.0
— MRPD	Yes; Requirement: IRT
 Switchover time on line break, typ. 	200 ms; For MRP, bumpless for MRPD
 Number of stations in the ring, max. 	50
SIMATIC communication	
 PG/OP communication 	Yes; encryption with TLS V1.3 pre-selected
• S7 routing	Yes
Data record routing	Yes
 S7 communication, as server 	Yes
 S7 communication, as client 	Yes
User data per job, max.	See online help (S7 communication, user data size)
Open IE communication	
• TCP/IP	Yes
— Data length, max.	64 kbyte
 several passive connections per port, supported 	Yes
• ISO-on-TCP (RFC1006)	Yes
— Data length, max.	64 kbyte
• UDP	Yes
— Data length, max.	2 kbyte; 1 472 bytes for UDP broadcast
— UDP multicast	Yes; Max. 5 multicast circuits
• DHCP	Yes
• DNS	Yes
• SNMP	Yes
• DCP	Yes
• LLDP	Yes
• Encryption	Yes; Optional
Web server	Very Observational and conservation
• HTTP	Yes; Standard and user pages
• HTTPS	Yes; Standard and user pages
OPC UA	V
Runtime license required	Yes
OPC UA Client Application path actions	Yes
Application authentication	Yes
— Security policies	Available security policies: None, Basic128Rsa15, Basic256Rsa15, Basic256Sha256
User authentication	"anonymous" or by user name & password
	,

Number of compatibility and	
— Number of connections, max. 4	
 Number of nodes of the client interfaces, recommended max. 	
Number of elements for one call of OPC_UA_NodeGetHandleList/OPC_UA_ReadList/OPC_U max.	
Number of elements for one call of OPC_UA_NameSpaceGetIndexList, max.	
— Number of elements for one call of OPC_UA_MethodGetHandleList, max.	
Number of simultaneous calls of the client 1 instructions for session management, per connection, max.	
 Number of simultaneous calls of the client instructions for data access, per connection, max. 	
Number of registerable nodes, max.5 000	
Number of registerable method calls of OPC_UA_MethodCall, max.	
Number of inputs/outputs when calling OPC_UA_MethodCall, max.	
OPC UA Server Yes; Data	access (read, write, subscribe), method call, custom address space
— Application authentication Yes	
• •	security policies: None, Basic128Rsa15, Basic256Rsa15, ha256
	us" or by user name & password
Number of sessions, max.32	
Number of accessible variables, max.	
Number of registerable nodes, max.	
Number of subscriptions per session, max.	
3 3 3	
— Publishing interval, min. 500 ms	
— Number of server methods, max. 20	
 Number of inputs/outputs per server method, max. 	
	1 s sampling interval and 1 s send interval
	"Server interfaces" / "Companion specification" type and 20 of the rence namespace"
Number of nodes for user-defined server interfaces, max.	
Further protocols	
MODBUS Yes; MOD	BUS TCP
S7 message functions	
Number of login stations for message functions, max. 32	
Program alarms Yes	
ProDiag or	gram messages are generated by the "Program_Alarm" block, GRAPH
Number of loadable program messages in RUN, max. 2 500	
Test commissioning functions	
Joint commission (Team Engineering) Yes; Paral	lel online access possible for up to 5 engineering systems
Status block Yes; Up to	8 simultaneously (in total across all ES clients)
Single step No	
Number of breakpoints 8	
Status/control	
Status/control variable Yes; witho	ut fail-safe
	outs, memory bits, DBs, distributed I/Os, timers, counters
Number of variables, max.	
— of which status variables, max. 200; per jo	b
— of which states variables, max. — of which control variables, max. 200; per jo	
Forcing	
	ut fail.safa
	inputs/outputs
Number of variables, max. 200	
Diagnostic buffer	
• present Yes	
• Number of entries, max. 1 000	
— of which powerfail-proof 500	

Traces	At the to 540 KD of data much
Number of configurable Traces	4; Up to 512 KB of data per trace are possible
Interrupts/diagnostics/status information	
Diagnostics indication LED	· ·
RUN/STOP LED	Yes
• ERROR LED	Yes
MAINT LED	Yes
Monitoring of the supply voltage (PWR-LED)	Yes
Connection display LINK TX/RX	Yes
Supported technology objects	
Motion Control	Yes; Note: The number of technology objects affects the cycle time of the PLC program; selection guide via the TIA Selection Tool
 Number of available Motion Control resources for technology objects 	800
Required Motion Control resources	
— per speed-controlled axis	40
— per positioning axis	80
— per synchronous axis	160
— per external encoder	80
— per output cam	20
— per cam track	160
— per probe	40
Positioning axis	
 Number of positioning axes at motion control cycle of 4 ms (typical value) 	5
 Number of positioning axes at motion control cycle of 8 ms (typical value) 	10
Controller	
PID_Compact	Yes; Universal PID controller with integrated optimization
PID_3Step	Yes; PID controller with integrated optimization for valves
PID-Temp	Yes; PID controller with integrated optimization for temperature
Counting and measuring	
High-speed counter	Yes
Standards, approvals, certificates	
Highest safety class achievable in safety mode	
 Performance level according to ISO 13849-1 	PLe
SIL acc. to IEC 61508	SIL 3
Probability of failure (for service life of 20 years and repair time	·
 Low demand mode: PFDavg in accordance with SIL3 	< 2.00E-05
Low demand mode: PFDavg in accordance with SIL3 High demand/continuous mode: PFH in accordance with SIL3	,
Low demand mode: PFDavg in accordance with SIL3 High demand/continuous mode: PFH in accordance with SIL3 Ambient conditions	< 2.00E-05
Low demand mode: PFDavg in accordance with SIL3 High demand/continuous mode: PFH in accordance with SIL3 Ambient conditions Ambient temperature during operation	< 2.00E-05 < 1.00E-09
Low demand mode: PFDavg in accordance with SIL3 High demand/continuous mode: PFH in accordance with SIL3 Ambient conditions Ambient temperature during operation • horizontal installation, min.	< 2.00E-05 < 1.00E-09 -25 °C; No condensation
— Low demand mode: PFDavg in accordance with SIL3 — High demand/continuous mode: PFH in accordance with SIL3 Ambient conditions Ambient temperature during operation • horizontal installation, min. • horizontal installation, max.	< 2.00E-05 < 1.00E-09 -25 °C; No condensation 60 °C
— Low demand mode: PFDavg in accordance with SIL3 — High demand/continuous mode: PFH in accordance with SIL3 Ambient conditions Ambient temperature during operation • horizontal installation, min. • horizontal installation, max. • vertical installation, min.	< 2.00E-05 < 1.00E-09 -25 °C; No condensation 60 °C -25 °C; No condensation
— Low demand mode: PFDavg in accordance with SIL3 — High demand/continuous mode: PFH in accordance with SIL3 Ambient conditions Ambient temperature during operation • horizontal installation, min. • horizontal installation, max. • vertical installation, min. • vertical installation, max.	< 2.00E-05 < 1.00E-09 -25 °C; No condensation 60 °C
— Low demand mode: PFDavg in accordance with SIL3 — High demand/continuous mode: PFH in accordance with SIL3 Ambient conditions Ambient temperature during operation • horizontal installation, min. • horizontal installation, max. • vertical installation, min. • vertical installation, max. Altitude during operation relating to sea level	< 2.00E-05 < 1.00E-09 -25 °C; No condensation 60 °C -25 °C; No condensation 50 °C
— Low demand mode: PFDavg in accordance with SIL3 — High demand/continuous mode: PFH in accordance with SIL3 Ambient conditions Ambient temperature during operation • horizontal installation, min. • horizontal installation, max. • vertical installation, min. • vertical installation, max. Altitude during operation relating to sea level • Installation altitude above sea level, max.	< 2.00E-05 < 1.00E-09 -25 °C; No condensation 60 °C -25 °C; No condensation
— Low demand mode: PFDavg in accordance with SIL3 — High demand/continuous mode: PFH in accordance with SIL3 Ambient conditions Ambient temperature during operation • horizontal installation, min. • horizontal installation, max. • vertical installation, min. • vertical installation, max. Altitude during operation relating to sea level • Installation altitude above sea level, max. configuration / header	< 2.00E-05 < 1.00E-09 -25 °C; No condensation 60 °C -25 °C; No condensation 50 °C
— Low demand mode: PFDavg in accordance with SIL3 — High demand/continuous mode: PFH in accordance with SIL3 Ambient conditions Ambient temperature during operation • horizontal installation, min. • horizontal installation, max. • vertical installation, min. • vertical installation, max. Altitude during operation relating to sea level • Installation altitude above sea level, max. configuration / header configuration / programming / header	< 2.00E-05 < 1.00E-09 -25 °C; No condensation 60 °C -25 °C; No condensation 50 °C
— Low demand mode: PFDavg in accordance with SIL3 — High demand/continuous mode: PFH in accordance with SIL3 Ambient conditions Ambient temperature during operation • horizontal installation, min. • horizontal installation, max. • vertical installation, min. • vertical installation, max. Altitude during operation relating to sea level • Installation altitude above sea level, max. configuration / header configuration / programming / header Programming language	< 2.00E-05 < 1.00E-09 -25 °C; No condensation 60 °C -25 °C; No condensation 50 °C 5 000 m; Restrictions for installation altitudes > 2 000 m, see manual
— Low demand mode: PFDavg in accordance with SIL3 — High demand/continuous mode: PFH in accordance with SIL3 Ambient conditions Ambient temperature during operation • horizontal installation, min. • horizontal installation, max. • vertical installation, min. • vertical installation, max. Altitude during operation relating to sea level • Installation altitude above sea level, max. configuration / header configuration / programming / header Programming language — LAD	< 2.00E-05 < 1.00E-09 -25 °C; No condensation 60 °C -25 °C; No condensation 50 °C 5 000 m; Restrictions for installation altitudes > 2 000 m, see manual Yes; incl. failsafe
— Low demand mode: PFDavg in accordance with SIL3 — High demand/continuous mode: PFH in accordance with SIL3 Ambient conditions Ambient temperature during operation • horizontal installation, min. • horizontal installation, max. • vertical installation, min. • vertical installation, max. Altitude during operation relating to sea level • Installation altitude above sea level, max. configuration / header configuration / programming / header Programming language — LAD — FBD	< 2.00E-05 < 1.00E-09 -25 °C; No condensation 60 °C -25 °C; No condensation 50 °C 5 000 m; Restrictions for installation altitudes > 2 000 m, see manual Yes; incl. failsafe Yes; incl. failsafe
— Low demand mode: PFDavg in accordance with SIL3 — High demand/continuous mode: PFH in accordance with SIL3 Ambient conditions Ambient temperature during operation • horizontal installation, min. • horizontal installation, max. • vertical installation, min. • vertical installation, max. Altitude during operation relating to sea level • Installation altitude above sea level, max. configuration / header configuration / programming / header Programming language — LAD — FBD — STL	< 2.00E-05 < 1.00E-09 -25 °C; No condensation 60 °C -25 °C; No condensation 50 °C 5 000 m; Restrictions for installation altitudes > 2 000 m, see manual Yes; incl. failsafe Yes; incl. failsafe Yes
— Low demand mode: PFDavg in accordance with SIL3 — High demand/continuous mode: PFH in accordance with SIL3 Ambient conditions Ambient temperature during operation • horizontal installation, min. • horizontal installation, max. • vertical installation, min. • vertical installation, max. Altitude during operation relating to sea level • Installation altitude above sea level, max. configuration / header configuration / programming / header Programming language — LAD — FBD — STL — SCL	< 2.00E-05 < 1.00E-09 -25 °C; No condensation 60 °C -25 °C; No condensation 50 °C 5 000 m; Restrictions for installation altitudes > 2 000 m, see manual Yes; incl. failsafe Yes; incl. failsafe Yes Yes
— Low demand mode: PFDavg in accordance with SIL3 — High demand/continuous mode: PFH in accordance with SIL3 Ambient conditions Ambient temperature during operation • horizontal installation, min. • horizontal installation, max. • vertical installation, min. • vertical installation, max. Altitude during operation relating to sea level • Installation altitude above sea level, max. configuration / header configuration / programming / header Programming language — LAD — FBD — STL — SCL — GRAPH	< 2.00E-05 < 1.00E-09 -25 °C; No condensation 60 °C -25 °C; No condensation 50 °C 5 000 m; Restrictions for installation altitudes > 2 000 m, see manual Yes; incl. failsafe Yes; incl. failsafe Yes
— Low demand mode: PFDavg in accordance with SIL3 — High demand/continuous mode: PFH in accordance with SIL3 Ambient conditions Ambient temperature during operation • horizontal installation, min. • horizontal installation, max. • vertical installation, min. • vertical installation, max. Altitude during operation relating to sea level • Installation altitude above sea level, max. configuration / header configuration / programming / header Programming language — LAD — FBD — STL — SCL — GRAPH Know-how protection	< 2.00E-05 < 1.00E-09 -25 °C; No condensation 60 °C -25 °C; No condensation 50 °C 5 000 m; Restrictions for installation altitudes > 2 000 m, see manual Yes; incl. failsafe Yes; incl. failsafe Yes Yes Yes
— Low demand mode: PFDavg in accordance with SIL3 — High demand/continuous mode: PFH in accordance with SIL3 Ambient conditions Ambient temperature during operation • horizontal installation, min. • horizontal installation, max. • vertical installation, min. • vertical installation, max. Altitude during operation relating to sea level • Installation altitude above sea level, max. configuration / header configuration / programming / header Programming language — LAD — FBD — STL — SCL — GRAPH Know-how protection • User program protection/password protection	< 2.00E-05 < 1.00E-09 -25 °C; No condensation 60 °C -25 °C; No condensation 50 °C 5 000 m; Restrictions for installation altitudes > 2 000 m, see manual Yes; incl. failsafe Yes; incl. failsafe Yes Yes Yes Yes
— Low demand mode: PFDavg in accordance with SIL3 — High demand/continuous mode: PFH in accordance with SIL3 Ambient conditions Ambient temperature during operation • horizontal installation, min. • horizontal installation, max. • vertical installation, min. • vertical installation, max. Altitude during operation relating to sea level • Installation altitude above sea level, max. configuration / header configuration / programming / header Programming language — LAD — FBD — STL — SCL — GRAPH Know-how protection	< 2.00E-05 < 1.00E-09 -25 °C; No condensation 60 °C -25 °C; No condensation 50 °C 5 000 m; Restrictions for installation altitudes > 2 000 m, see manual Yes; incl. failsafe Yes; incl. failsafe Yes Yes Yes

Access protection	
 protection of confidential configuration data 	Yes
 Protection level: Write protection 	Yes
 Protection level: Read/write protection 	Yes
 Protection level: Write protection for Failsafe 	Yes
Protection level: Complete protection	Yes
programming / cycle time monitoring / header	
 lower limit 	adjustable minimum cycle time
• upper limit	adjustable maximum cycle time
Dimensions	
Width	100 mm
Height	117 mm
Depth	75 mm
Weights	
Weight, approx.	310 g

last modified: 4/25/2024 🖸